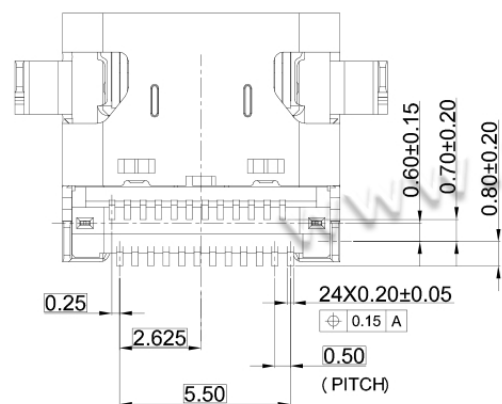
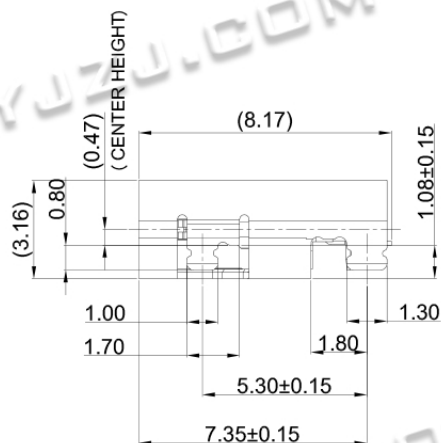
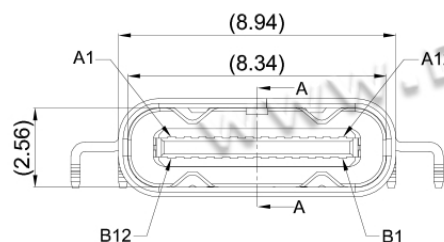
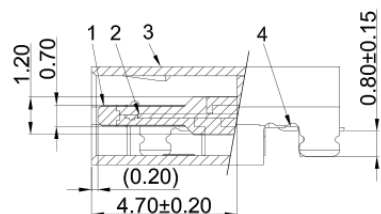
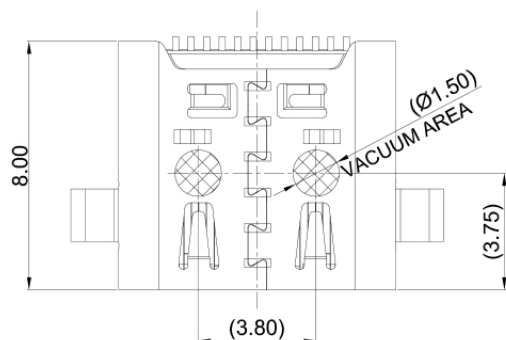


NOTE/注释:

1. SPECIFICATION/规格:

- 1.1 Rated current (额定电流): 5.0 A
- 1.2 Voltage rating (额定电压): 5V AC
- 1.3 Contact Resistance (接触阻抗): 40 mΩ Max.
- 1.4 Insulation Resistance (绝缘阻抗): 100MΩ Min.
- 1.5 Withstanding voltage (耐电压): 100 VAC/minute
- 1.6 Mating force (插入力): 5~20N.
- 1.7 Unmating force (拔出力): 8~20N.
- 1.8 Durability Cycle(寿命循环): 10,000 cycle
- 1.9 Operating temperature (工作温度): -40°~+85°

PIN ASSIGNMENT

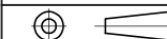
A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12
GND	TX1+	TX1-	Vbus	CC1	D+	D-	SBU1	Vbus	RX2-	RX2+	GND
B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1
GND	RX1+	RX1-	Vbus	SBU2	D-	D+	CC2	Vbus	TX2-	TX2+	GND



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TOLERANCE:

X.X	±0.30
X.XX	±0.25
X.XXX	±0.15
X.* ±2*	X.* ±0.5*



UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY:

陈一鸣

CHECKED BY:

马跃

APPROVED BY:

邱敏

DATE:

2014-02-23

DATE:

2014-02-23

DATE:

2014-02-23

PART NAME: USB TYPE C 4.0母座24P
双贴SMT 沉板有DIP脚CH=0.5 L=8.17

PART NO.

HYC466-USBC24-817

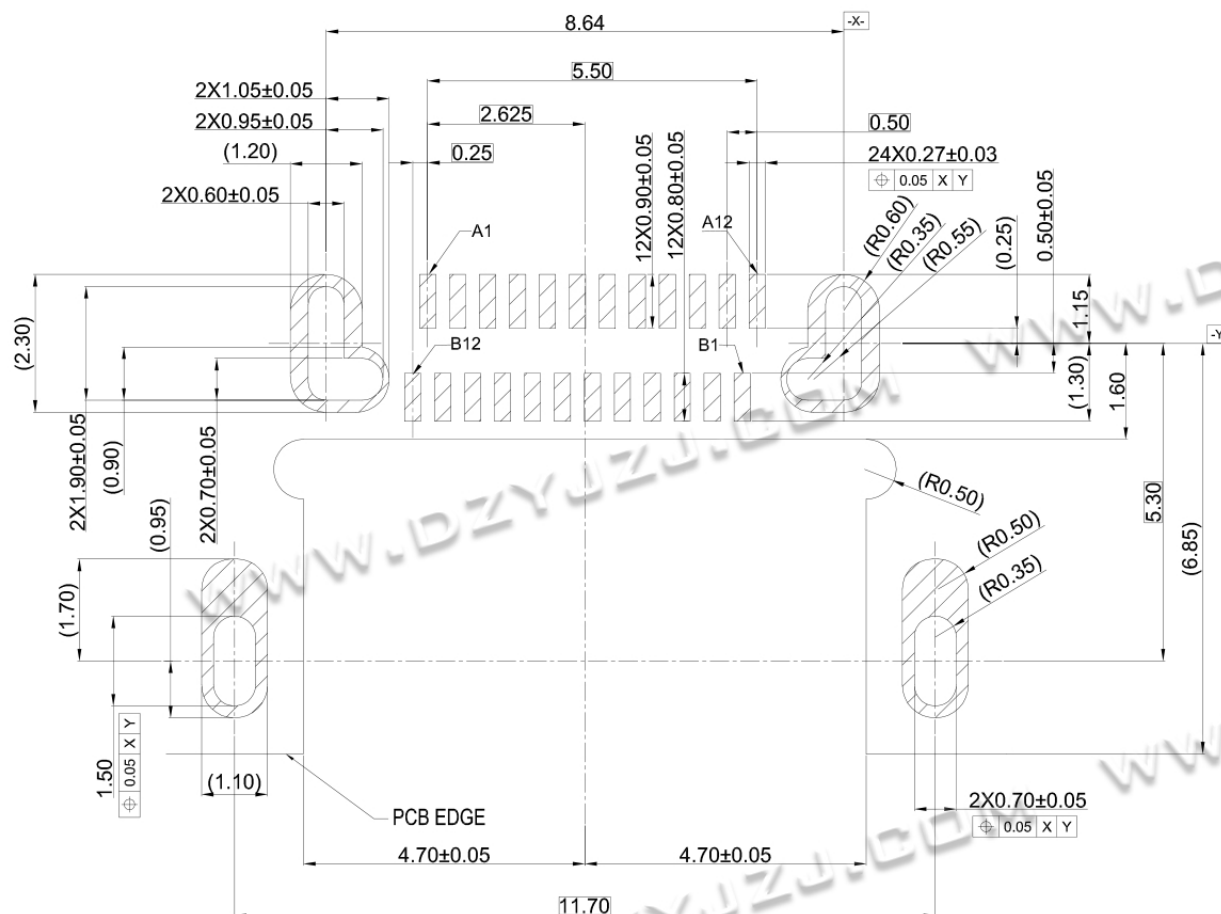
MOLD NO.

DRAW NO:

HYC-2310111009

SHEET NO.

1 OF 1



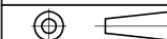
4	TERMINAL	24	COPPER ALLOY	MATING SIDE:SEE PART NO; SOLDER TAIL:Gold FLASH, 50u" NICKEL OVERALL.	T=0.12
3	SHELL	1	SUS304	30U" NICKEL PLATING	T=0.30
2	MID PLATE	1	SUS301-H	30U" NICKEL PLATING	T=0.15
1	MAIN HOUSING	1	HIGH TEMPERATURE	PA9T BLACK	UL94V-0
ITEM	DESCRIPTION	QTY	MATERIAL	FINISH	REMARK
BILL OF MATERIAL					



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TOLERANCE:
X.X ±0.30
X.XX ±0.25
X.XXX ±0.15

X.* ±2" X.* ±0.5"



UNIT: mm [inch]

SCALE:1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME: USB TYPE C 4.0母座24P

双贴SMT 沉板有DIP脚CH=0.5 L=8.17

CHECKED BY:

马跃

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SHEET NO.

1 OF 1